

CONTAVAL[®] GP/AP/HT

Composition

CONTAVAL[®] GP/AP/HT is a special thermal treated semi conductive laminate consisting of E-glass cloth, conductive additives and a multifunctional epoxy-resin.

Application

CONTAVAL[®] GP/AP/HT is used as soldering bath carriers for printed circuits, when sensitive components ask for ESD working conditions.

According to VDE 0472/ part 813 the conflagration gases of CONTAVAL[®] GP/AP/HT is non-corrosive.

Availability

Thickness: 2 - 30 mm

Standard sheet size: 2140 +10/-0 mm x 1240 +10/-0 mm (up to 30 mm thickness)
2800 +10/-0 mm x 1240 +10/-0 mm (up to 30 mm thickness)

Thickness, mm	Thickness tolerance, mm
3	-0/+0.30
5	-0/+0.50
6	-0/+0.60
8	-0/+0.80
10	-0/+1

Colour: black

Machined parts and cuttings, other sheet sizes and thicknesses are also available upon request.

Machining Recommendation

CONTAVAL[®] GP/AP/HT can be easily cut with hammer shears or punching machines (up to 1 mm). For thicker laminates we advise to use diamond tipped tools and high speed machinery.

All information given here is based on currently available facts and on the results of experiments performed with all due care in our laboratories. It does not in any way reduce the responsibility of the user for carrying out further tests in order to ensure successful processing and use in specific applications.

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TECHNICAL DATA

Properties	Norm	Unit	Value
Density	DIN 53479	g/cm ³	1.7-1.9
Flexural strength at 23°C	DIN 53452	MPa	≥380
Flexural strength at 150°C	DIN 53479	g/cm ³	≥190
Flexural strength at 180°C	DIN 53452	MPa	≥140
Flexural modulus of elasticity	ISO 178	MPa	approx. 20000
Surface resistivity	IEC 6093	Ω/square	10 ⁵ -10 ⁹
Compressive strength perpendicular to laminations 23°C	ISO 604	MPa	400
Tensile strength	ISO 527	MPa	240
Poisson's ratio	ISO 527		0.150
Thermal conductivity	DIN 52612	W/mK	0.3
Linear coefficient of expansion (parallel)	VDE 0304/2	1/K	≤ 1.0 x 10 ⁻⁵
Thermal classification			180°C (H)
Short term temperature exposure	IEC 60216		350°C

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